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6-1-04 10276	0589 U.S. DEPARTMENT OF COMMERCES
(Rev. 03/01) RECORDATION FOR	U.S. Patent and Trademark Office
OMB No. 0651-0027 (exp. 5/31/2002)	
To the Honorable Commissioner of Patents and Trademarks: P	
Name of conveying party(ies):	2. Name and address of receiving party(ies)
Chandra Mouli (05/10/2004)	Name: MICRON TECHNOLOGY, INC.
	Internal Address:
Additional name(s) of conveying party(ies)  Additional name(s) of conveying party(ies)  Yes X No	Street Address:
3. Nature of Conveyance:	8000 S. Federal Way
x Assignment Merger	
Security Agreement Change of Name	City: Boise
Other	State: ID Zip: 83706-9632
Execution Date: May 10, 2004	Additional name(s) & Yes x No
Execution Date. May 10, 2004	address(es) attached:
A. Patent Application No.(s):     This application     Additional numbers attach	B. Patent No.(s): ed? Yes X No
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Thomas J. D'Amico DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP	7. Total fee (37 CFR 3.41) \$40.00
Internal Address: Atty. Dkt.: M4065.1010/P1010	Enclosed
Street Address:	Authorized to be charged to deposit account
2101 L Street NW	x Authorized to be charged to credit card (Form 2038 enclosed)
1	8. Deposit account number:
City: State: Zip: Washington DC 20037-1526	04-1073
	(Attach duplicate copy of this page if paying by deposit account)
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<ol> <li>Statement and signature.</li> <li>To the best of my knowledge and belief, the foregoing info is a true copy of the original document.</li> </ol>	ormation is true and correct and any attached copy
Thomas J. D'Amico (28,371)	June 1, 2004
Name of Person Signing	Signature Date
Total number of pages including cover sheet, attac	hments, and documents: 3

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1776571 v1; 122T701!.DOC

Docket No.: M4065.1010/P1010

## ASSIGNMENT AND AGREEMENT

For value received, I, Chandra Mouli, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled SILICON-BASED RESONANT CAVITY PHOTODIODE FOR IMAGE SENSORS, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

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PATENT REEL: 015405 FRAME: 0953

Docket No.: M4065.1010/P1010

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

V.(	/ <sup>U</sup> W/		 	
Chand	ra Mou	i		

11/1/2

Date:	5	(0	204	[		

County of Para )

On this day of you, , down to be the individual described in and who executed the foregoing instrument, and acknowledged execution

of the same.

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RECORDED: 06/01/2004

PATENT REEL: 015405 FRAME: 0954